

RFMA2124-2W-P3

21.2 - 23.6 GHz Power Amplifier MMIC

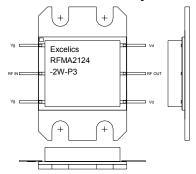
FEATURES

UPDATED: 01/09/2007

- 21.2–23.6GHz Operating Frequency Range
- 31.0dBm Output Power at 1dB Compression
- 22dB Typical Power Gain @ 1dB Gain Compression
- -39dBc Typical OIM3 @ each tone Pout 20dBm

APPLICATIONS

- Point-to-point and point-to-multipoint radio
- Military Radar Systems





Caution! ESD sensitive device.

ELECTRICAL CHARACTERISTICS (T_a = 25 °C, 50 ohm, Vdd=7V, Vgg=-5V)

SYMBOL	PARAMETER/TEST CONDITIONS	MIN	TYP	MAX	UNITS
F	Operating Frequency Range	21.2		23.6	GHz
P1dB	Output Power at 1dB Gain Compression	30.0	31.0		dBm
G1dB	Gain @ 1dB gain compression	18.0	22.0		dB
OIMD3	Output 3 rd Order Intermodulation Distortion @∆f=10MHz, Each Tone Pout 20dBm		-39	-36	dBc
Input RL	Input Return Loss		-10		dB
Output RL	Output Return Loss		-15	-10	dB
ldd	Drain Current		1700	2300	mA
Vdd	Drain Voltage		7	8	V
Vgg	Gate Voltage		-5		V
Rth	Thermal Resistance (Au-Sn Eutectic Attach)		4.0	4.5	°C/W
Tb	Operating Base Plate Temperature	-30		+80	°C

MAXIMUM RATINGS @25°C

SYMBOL	CHARACTERISTIC	ABSOLUTE	CONTINUOUS 1,2	
V_{DD}	Drain Supply Voltage	12V	8V	
V_{GG}	Gate Supply Voltage	-8V	-3V	
I _{DD}	Drain Current	ldss	3.6A	
P _{IN}	Input Power	20dBm	@ 3dB compression	
T _{CH}	Channel Temperature	175°C	150°C	
T _{STG}	Storage Temperature	-65/175°C	-65/150°C	
P_{T}	Total Power Dissipation	30.0W	25.2W	

^{1.} Operating the device beyond any of the above rating may result in permanent damage.

^{2.} Bias conditions must also satisfy the following equation $Vdd^*Idd < (T_{CH} - Tb)/R_{TH}$; where T_b = operating base plate temperature

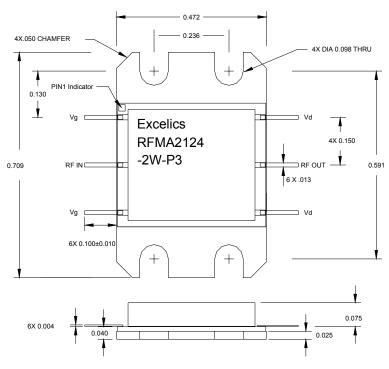


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P3 Package Outline



DIMENSION: INCH TOLERANCE: ±0.005

Ordering Information

Part Number	
RFMA2124-2W-P3	Refer P3 Package Outline

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- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.